

May 2001

FQP27P06

60V P-Channel MOSFET

General Description

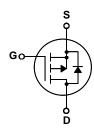
These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand a high energy pulse in the avalanche and commutation modes. These devices are well suited for low voltage applications such as automotive, DC/DC converters, and high efficiency switching for power management in portable and battery operated products.

Features

- -27A, -60V, $R_{DS(on)}$ = 0.07 Ω @V_{GS} = -10 V Low gate charge (typical 33 nC)
- Low Crss (typical 120 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- 175°C maximum junction temperature rating





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQP27P06	Units
V_{DSS}	Drain-Source Voltage		-60	V
I _D	Drain Current - Continuous (T _C = 25	°C)	-27	А
	- Continuous (T _C = 100°C)		-19.1	А
I _{DM}	Drain Current - Pulsed	(Note 1)	-108	А
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	560	mJ
I _{AR}	Avalanche Current	(Note 1)	-27	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	12	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-7.0	V/ns
P _D	Power Dissipation (T _C = 25°C)		120	W
	- Derate above 25°C		0.8	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.25	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.5		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-60			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	I_D = -250 μ A, Referenced to 25°C		-0.06		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -60 V, V _{GS} = 0 V			-1	μΑ
		V _{DS} = -48 V, T _C = 150°C			-10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = -25 V, V _{DS} = 0 V			-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 25 V, V _{DS} = 0 V			100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -13.5 A		0.055	0.07	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -30 V, I _D = -13.5 A (Note 4)		12.4		S
C _{iss}	Input Capacitance Output Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		1100 510	1400 660	pF pF
C _{oss}	Output Capacitance Reverse Transfer Capacitance	f = 1.0 MHz		510 120	660 155	pF pF
-155	Treverse Transfer Supushanse			.20	100	Pi
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = -30 \text{ V}, I_{D} = -13.5 \text{ A},$		18	45	ns
t _r	Turn-On Rise Time	$R_{G} = 25 \Omega$		185	380	ns
t _{d(off)}	Turn-Off Delay Time			30	70	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		90	190	ns
Qg	Total Gate Charge	V _{DS} = -48 V, I _D = -27 A,		33	43	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -10 V		6.8		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		18		nC
D	Name of Dialog Olement and a diagrams	- I Mariana Badana				•
I _S	Source Diode Characteristics at				-27	Α
	Maximum Continuous Drain-Source Diode Forward Current Maximum Pulsed Drain-Source Diode Forward Current				-108	A
		V _{GS} = 0 V, I _S = -27 A			-4.0	V
V _{SD}	Drain-Source Diode Forward Voltage					
V _{SD}	Drain-Source Diode Forward Voltage Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_S = -27 \text{ A},$		105		ns

- Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 0.9mH, I $_{AS}$ = -27A, V $_{DD}$ = -25V, R $_{G}$ = 25 Ω , Starting T $_{J}$ = 25°C 3. I $_{SD}$ ≤ -27A, di/dt ≤ 300A/ $_{HS}$, V $_{DD}$ ≤ BV $_{DSS}$, Starting T $_{J}$ = 25°C 4. Pulse Test : Pulse width ≤ 300 $_{\mu}$, Duty cycle ≤ 2% 5. Essentially independent of operating temperature

Typical Characteristics

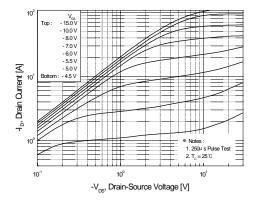


Figure 1. On-Region Characteristics

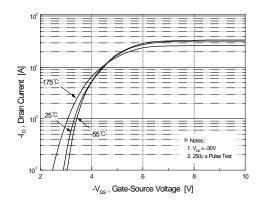


Figure 2. Transfer Characteristics

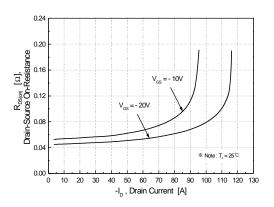


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

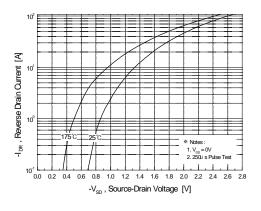


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

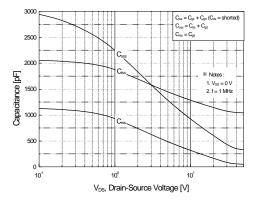


Figure 5. Capacitance Characteristics

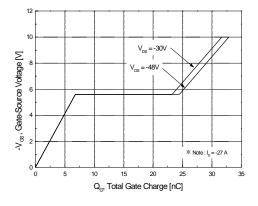


Figure 6. Gate Charge Characteristics

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Typical Characteristics (Continued)

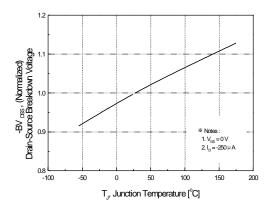
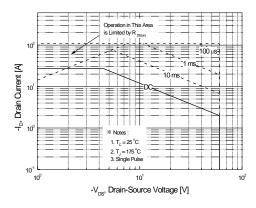


Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



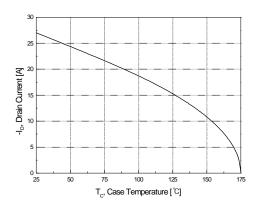


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

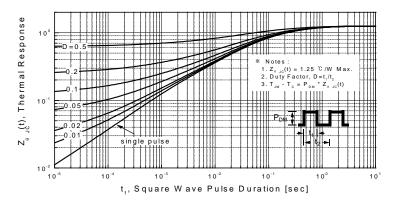
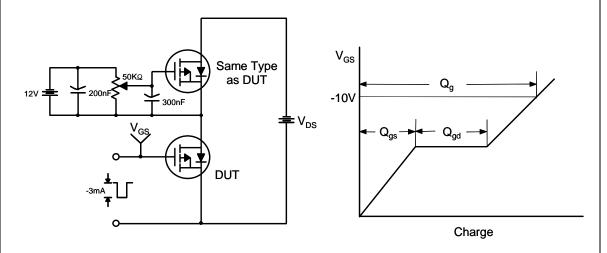


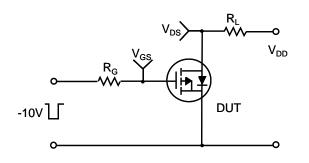
Figure 11. Transient Thermal Response Curve

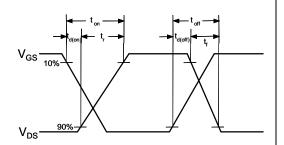
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Gate Charge Test Circuit & Waveform

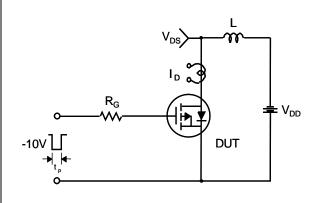


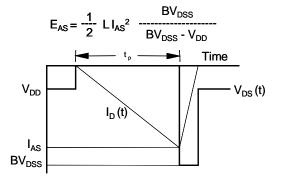
Resistive Switching Test Circuit & Waveforms



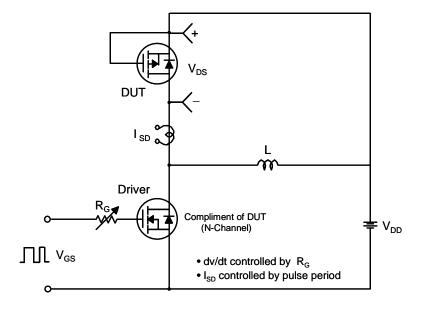


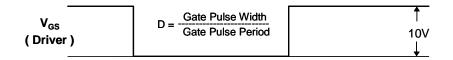
Unclamped Inductive Switching Test Circuit & Waveforms

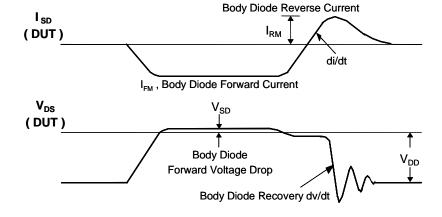


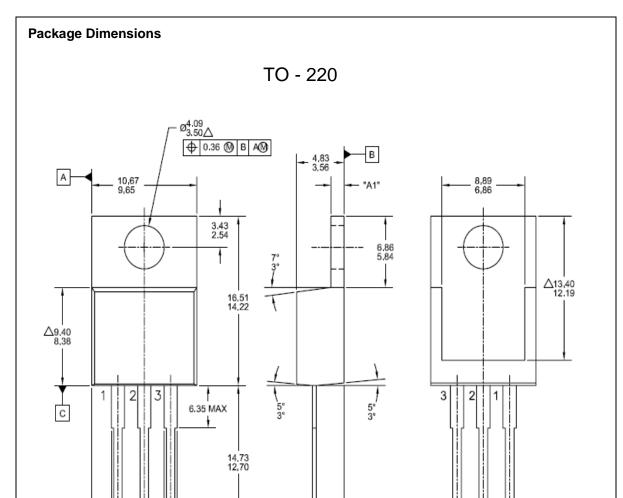


Peak Diode Recovery dv/dt Test Circuit & Waveforms







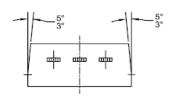


0.61 △0.33

2.92 2.03

1.02 0.38

→ 0.36 M B AM



5,08

Dimensions in Millimeters

(1.91) -

2.54

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